

## **Altera Device Package Information**

04R-00266-2.0

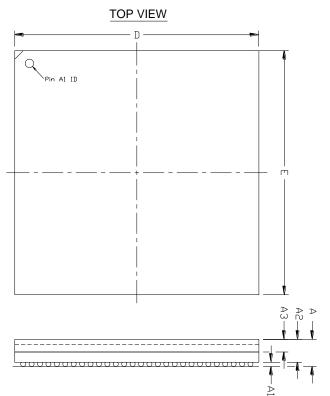
## 780-Pin FineLine Ball-Grid Array (FBGA) - Flip Chip - Channel Lid - A:3.40

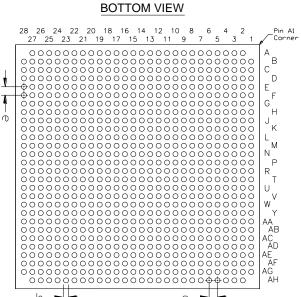
- All dimensions and tolerances conform to ASME Y14.5M 1994.
- Controlling dimension is in millimeters.
- Pin A1 may be indicated by an ID dot, or a special feature, in its proximity on package surface.

Package Information		
Description	Specification	
Ordering Code Reference	F	
Package Acronym	FBGA	
Substrate Material	ВТ	
Solder ball composition	Regular: 63Sn:37Pb (Typ.) Pb-free: Sn:3Ag:0.5Cu (Typ.)	
JEDEC Outline Reference	MS-034 Variation: AAM-1	
Lead Coplanarity	0.008 inch (0.20 mm)	
Weight	9.3 g (Typ.)	
Moisture Sensitivity Level	Printed on moisture barrier bag	

Package Outline D	ackage Outline Dimension Table			
Ol	Millimeters			
Symbol	Min.	Nom.	Max.	
Α	3.00	3.20	3.40	
A1	0.40	0.50	0.60	
A2	2.40	2.70	3.00	
А3	1.45	1.55	1.65	
D	29.00 BSC			
E	29.00 BSC			
b	0.50	0.60	0.70	
е	1.00 BSC			

## Package Outline





## **Document Revision History**

Table 1 shows the revision history for this document.

Table 1. Document Revision History

Date	Version	Changes
June 2011	1.0	Initial release
November 2012	2.0	Revised Package Outline at Page 2 to include the chamfer at TOP VIEW and update the SIDE VIEW.



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